

Preliminary

SOGNBA99-XTGA

FEATURES

- Single fiber bi-directional data links with symmetric 9.95Gbps downstream/upstream
- 4-Ch (100GHz CS) Tunable C-band DWDM EML burst mode transmitter
- 4-Ch (100GHz CS) Tunable L-band APD-TIA continuous mode receiver
- Up to 40km transmission distance with SMF
- Class 3 wavelength channel tuning time
- 0 to 70°C operating case temperature
- XFP package with SC/UPC receptacle
- 3.3V power supply
- CML logic level data input and output interfaces
- Rx loss of signal indication
- TX_SD function
- Digital diagnostic monitor (DDM) function
- Hot-pluggable capability
- Low EMI and excellent ESD protection
- Class 1 laser safety standard IEC-60825 compliant
- RoHS-6 compliance

APPLICATIONS

TWDM tunable NG-PON2 ONU

STANDARDS

- Complies with G.989.2
- Complies with SFF INF-8077i
- Complies with FCC 47 CFR Part 15, Class B
- Complies with 21 CFR 1040.10 and 1040.11

ABSOLUTE MAXIMUM RATING							
Parameter	Symbol	Min.	Max.	Unit	Notes		
Storage Ambient Temperature	T _{STG}	-40	85	°C			
Operating Case Temperature	Тс	0	70	°C			
Operating Humidity	ОН	5	85	%			
Power Supply Voltage	V _{CC3}	0	3.6	V			
Receiver Damaged Threshold			+5	dBm			

RECOMMENDED OPERATING CONDITION							
Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes	
Operating Case Temperature	Тс	0		70	°C		
Power Supply Voltage	V _{CC3}	3.13	3.3	3.47	V		
Power Supply Current	Icc			1060	mA		
Date Rate			Tx 9.95		Gbps		
			Rx 9.95		Gups		
Power Consumption	Р			3.5	W		

TRANSMITTER OPTICAL CHARACTERISTICS							
Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes	
Centre Wavelength	λ_{CT}	λ _i -0.16		λ _i +0.16	nm	Channel number i=1,2,3,4	
Average Output Power	Po	4		9	dBm		
Extinction Ratio	ER	6			dB		
Data Rate			9.95		Gbps		
Side Mode Suppression Ratio	SMSR	30			dB		
Burst off Average Output Power				-44	dBm		
Turn On Time at Burst mode	Ton			128	ns		
Turn Off Time at Burst mode	Toff			128	ns		
Transmitter Reflectance				-32	dB		
Tolerance to Tx Back Reflection		-15			dB		
Transmitter Dispersion Penalty	TDP			0.5	dB	over 20km SMF	
Output Optical Eye Diagram	Compliant With G989.2					PRBS 2 ³¹ -1 @9.95Gbps	
Transmitter Wavelength Channel Tuning Time				1	s		

TRANSMITTER ELECTRICAL CHARACTERISTICS							
Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes	
Data Input Differential Swing		120		850	mV	CML input, AC coupled	
Input Differential Impedance		90	100	110	Ω		
Transmitter burst control		0		0.8	V	Enable	
		2.0		V_{CC3}	V	Disable	
TX SD indication		-0.3		0.4	V	Tx OFF	
TX_SD indication		2.4		V _{CC3}	V	Tx ON	
TX Foult		-0.3		0.4	V	Normal	
TX Fault		2.4		V _{CC3}	V	Fault	

TRANSMITTER EYE MASK DEFINITION

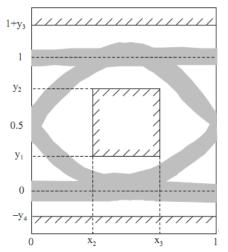


Figure 1 Mask of the eye diagram for ONU transmitter

X3-X2	Y1	Y2	Y3	Y4	Unit
0.2	0.25	0.75	0.25	0.25	UI

RECEIVER OPTICAL CHARACTERISTICS							
Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes	
Center Wavelength	λ_{CR}	λ _j -0.16		λ _j +0.16	nm	Channel number j=1,2,3,4	
Sensitivity	SEN			-28	dBm	PRBS 2 ³¹ -1 @9.95Gbit/s	
Saturation Optical Power	SAT	-7			dBm	BER<1E-3	
Loss of Signal De-Assert Level	LOSD			-30	dBm		
Loss of Signal Assert Level	LOSA	-45			dBm		
Loss of Signal Hysteresis		0.5		5	dB		
Receiver Reflectance				-20	dB		
Rx Wavelength Channel Tuning Time				1	S		

RECEIVER ELECTRIAL CHARACTERISTICS							
Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes	
Data Output Differential Swing		100		800	mV		
Loss of Signal - Low		-0.3		0.4	V		
Loss of Signal - High		2.4		V _{CC3}	V		

PIN DESCRI	PTION		
PIN	Name	Description	Notes
1	GND	Signal Ground	
2	TX_Fault	Transmitter Fault	LVTTL, internal pull-up
3	NC	No Connection	
4	TX_SD	Transmitter State Indication, TX_SD Assert When Transmitter ON	LVTTL, Internal pull-up
5	TX_BM	Transmitter Burst Mode Control	LVTTL, Transmitter on when TX_BM is low
6	NC	No Connection	
7	GND	Signal Ground	
8	V _{CC3T}	Transmitter Power Supply	
9	V _{CC3R}	Receiver Power Supply	
10	SCL	Clock Line of the I2C interface	The clock line of two wire serial interface
11	SDA	Data Line of the I2C interface	The data line of two wire serial interface
12	MOD_ABS	Module Absent	Connected to GND in the module
13	NC	No Connection	
14	RX_LOS	Receiver Loss of Signal Indication	LVTTL, Low: signal detected; High: loss of signal
15	GND	Signal Ground	
16	GND	Signal Ground	
17	RD-	Inverted Receiver Data Output	CML logic output, AC coupled
18	RD+	Non-inverted Receiver Data Output	CML logic output, AC coupled
19	GND	Signal Ground	
20	NC	No Connection	
21	MOD_DIS	High for sleep mode	
22	NC	No Connection	
23	GND	Signal Ground	
24	NC	No Connection	
25	NC	No Connection	
26	GND	Signal Ground	
27	GND	Signal Ground	
28	TD-	Transmitter Inverted Data Input	CML logic input, AC coupled
29	TD+	Transmitter Non-inverted Data Input	CML logic input, AC coupled
30	GND	Signal Ground	

PIN OUT DRAWING (TOP VIEW)

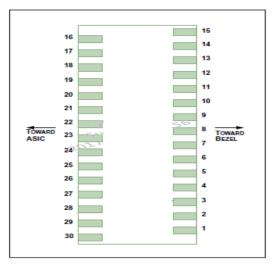


Figure 2 Pin out Drawing (Top view)

PACKAGE OUTLINE

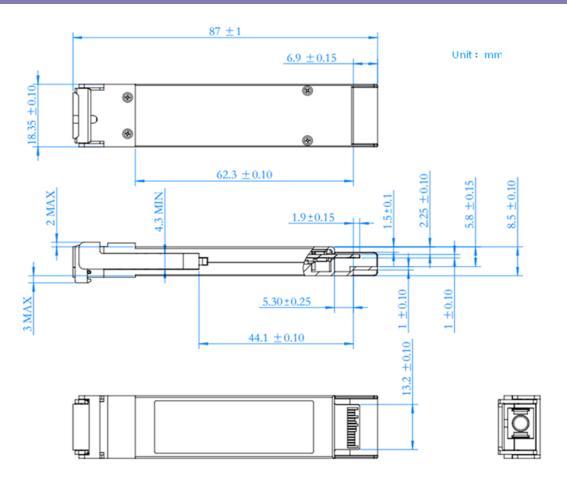


Figure 3 Package Outline (Unit: mm)

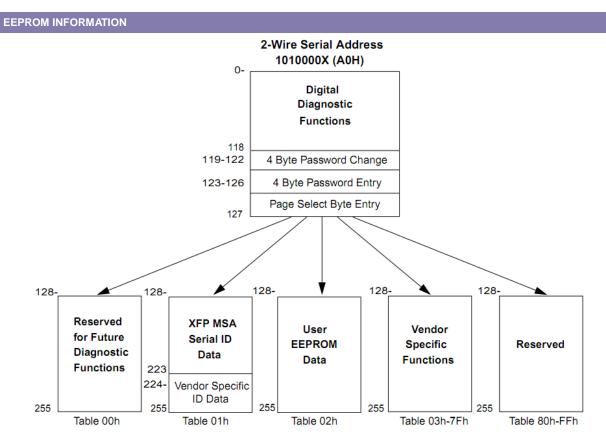


Figure 4 EEPROM Memory Map Specific Data Field Descriptions

WAVELENGTH CHANNEL DEFINITION

A0h [112]	Channel Number	Central Frequency (THz)	Wavelength (nm)
00h	1	195.6	1532.68
01h	2	195.5	1533.47
02h	3	195.4	1534.25
03h	4	195.3	1535.04

Transmitter wavelength channel code

A0h [72] (-128, 127) defines transmitter wavelength offset from its central wavelength set and default 00h

Receiver wavelength channel code

A0h [113]	Channel Number	Central Frequency (THz)	Wavelength (nm)
00h	1	187.8	1596.34
01h	2	187.7	1597.19
02h	3	187.6	1598.04
03h	4	187.5	1598.89

A0h [73] (-128, 127) defines receiver wavelength offset from its central wavelength set and default 00h

DIGITAL DIAGNOSTIC MONITORING INTERFACE						
Parameter	Range	Accuracy	Calibration	NOTES		
Temperature	0 to 70°C	±3°C	Internal	LSB: 1/256C		
Voltage	3.0 to 3.6V	±3%	Internal	LSB: 0.1mV		
Bias Current	0 to 131mA	±10%	Internal	LSB: 2uA		
TX Power	0 to +9dBm	±2dB	Internal	LSB: 0.2uW		
RX Power	-28 to -7dBm	±2dB	Internal	LSB: 0.1uW		

ORDERING INFORMATION		
PN	Temperature Rating	Unit
SOGNBA99-XTGA	0 ~ 70	C°

WARNINGS

- Handling Precautions: This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.
- Laser Safety: Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.